NAirBorn



High-Density, Rugged Connectors

Smaller Doesn't Mean Less

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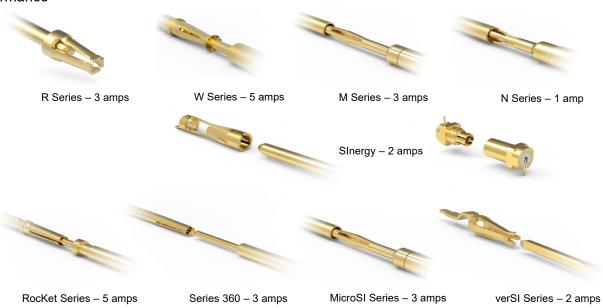




The term "rugged & reliable" is a common phrase used in countless marketing pieces within the electronic component industry. That distinction is also applied specifically to connectors, one of the core components of many electronic systems. Because no easily-referenced grading system exists to distinguish truly rugged & reliable connectors from commercial-grade connectors only claiming to be, engineers must see through the marketing hype to determine a connector's true nature.

Rugged and Reliable Design

- What makes a connector RUGGED?
 - Contact size, durability, and performance
 - Design Features
 - Materials
- Development of new rugged interconnect solutions
 - VoC
 - SWaP-C
- Industry Applications
 - Smaller doesn't mean less



Rugged Contact Base Material

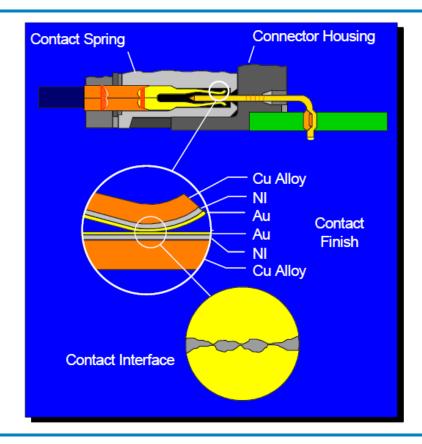
Contact base materials play a central role in delivering proper contact normal force through spring performance, but also:

- · Electrical conductivity
- · Thermal conductivity
- Ease of fabrication
- Material costs

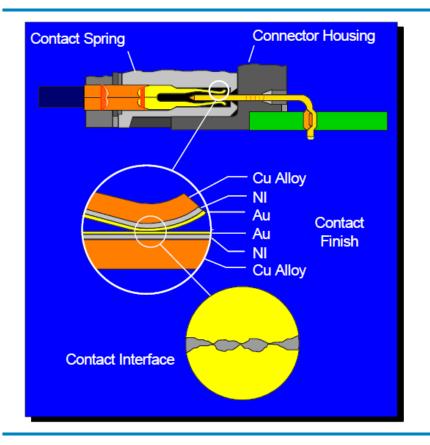
Beryllium Copper (BeCu), is the base material-ofchoice for spring member contacts in ultra-high reliability connectors

- High-yield strength
- High hardness
- Added formability and spring stability
- Very high fatigue resistance, a critical facet of high-endurance components, especially under cyclic loads

Phosphor Bronze or **Brass** is often the material-ofchoice for non-spring contact members such as pins



Rugged Contact Plating Material



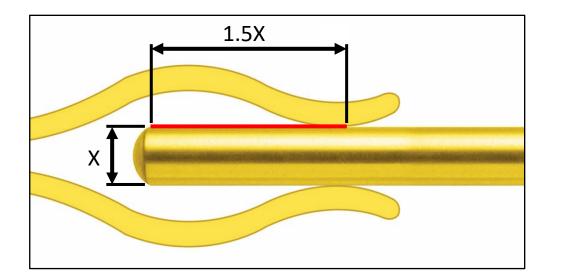
Contact plating, or metal used to coat the base material at the mating face, is classically gold due to its resistance to corrosion, thus sustaining consistent electrical conductivity.

Gold also provides a very durable connection provided a 50μ in coating thickness is used

Industrial grade connectors typically have gold thicknesses of less than 30μ in, typically $10-15\mu$ in

Commercial grade connectors often use tin plating instead of gold plating. In addition, our rugged connectors have an added **Nickel under plate** to keep the copper from bleeding through.

Contact wipe is the distance that the spring member 'wipes' across the non-spring member when the pin and socket fully mate.



At AirBorn, we require the wipe distance to be a minimum of 1.5 times the diameter of the pin

- Removes any oxidation present for clean connection
- Provides mating tolerance to ensure electrical connection

What Makes A Rugged Contact?



Science & engineering on a microscopic level.





Rugged Metal Shells – Space/Mil-Grade Materials



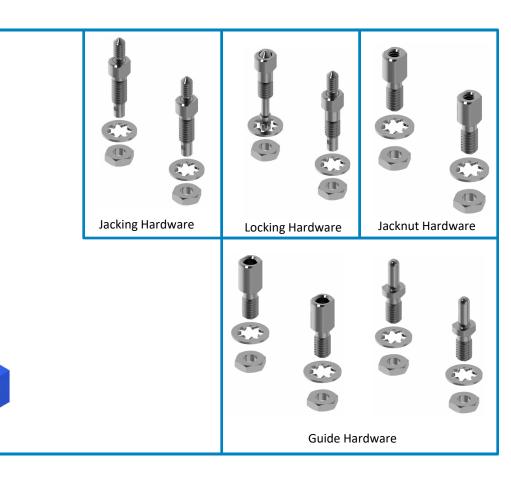
- Nickel-plated metal shells
- LCP/PPS Molded Insulators
- All non-metallic materials meet space outgassing requirements per ASTM E595
- Epoxy Sealed Contacts/Insulators





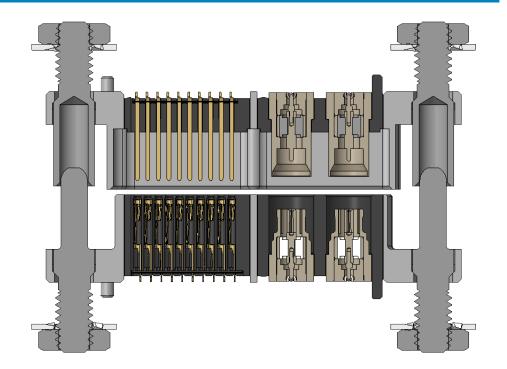
Mating/Mounting Hardware

- Guide/Jacking/Locking
- Field replaceable and swappable
- Hardware used to mount connector to PCB
- Integrated into the interface

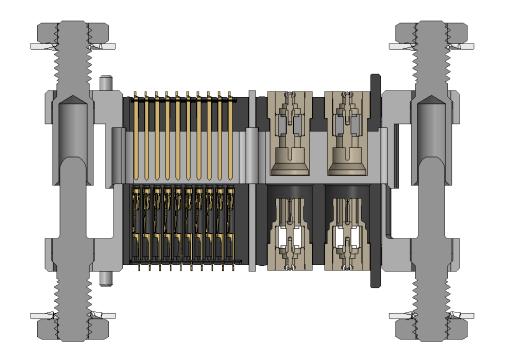


Mating Sequence – Fool Proof? Likely Not!

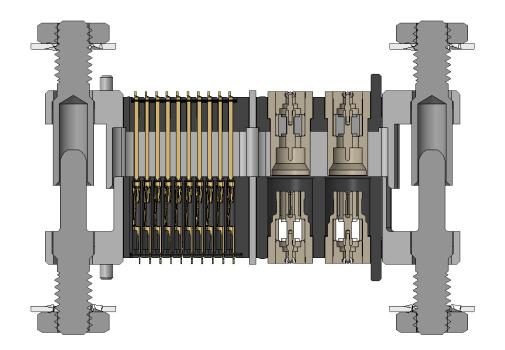
Hardware engages



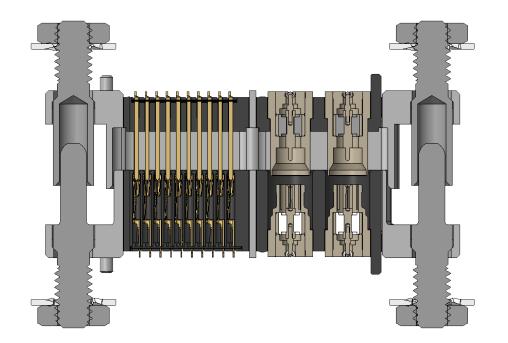
Hardware engages Metal shells engage



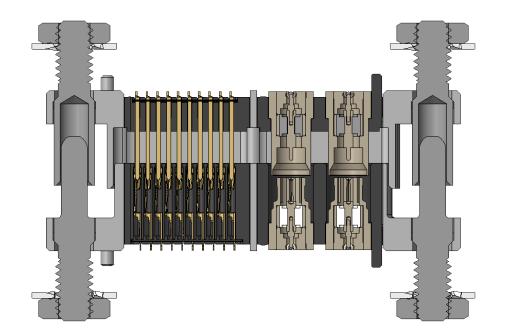
Hardware engages ↓ Metal shells engage ↓ HD pins engage insulator

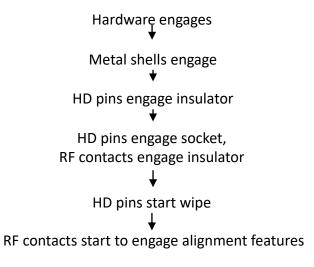


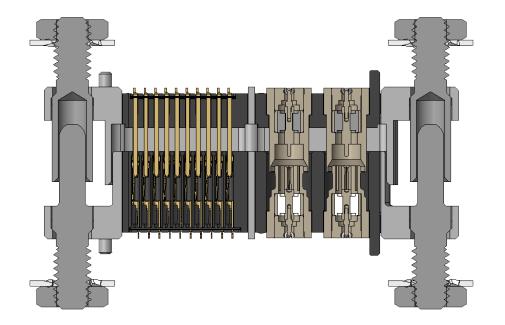
Hardware engages ↓ Metal shells engage ↓ HD pins engage insulator ↓ HD pins engage socket, RF contacts engage insulator



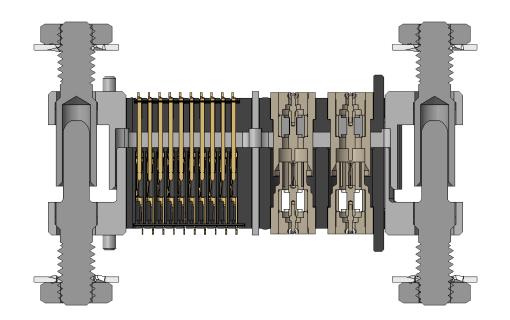
Hardware engages ↓ Metal shells engage ↓ HD pins engage insulator ↓ HD pins engage socket, RF contacts engage insulator ↓ HD pins start wipe



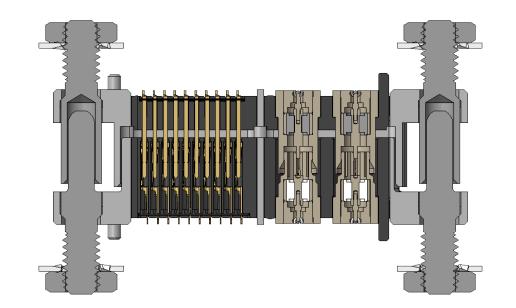




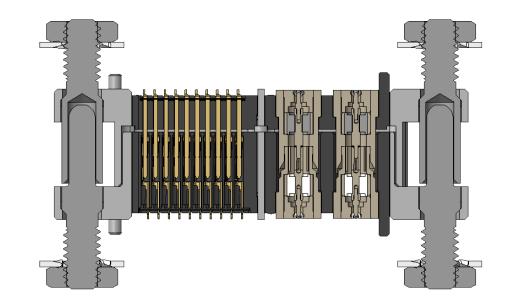
Hardware engages Metal shells engage HD pins engage insulator HD pins engage socket, RF contacts engage insulator HD pins start wipe RF contacts start to engage alignment features RF ground contacts start wipe



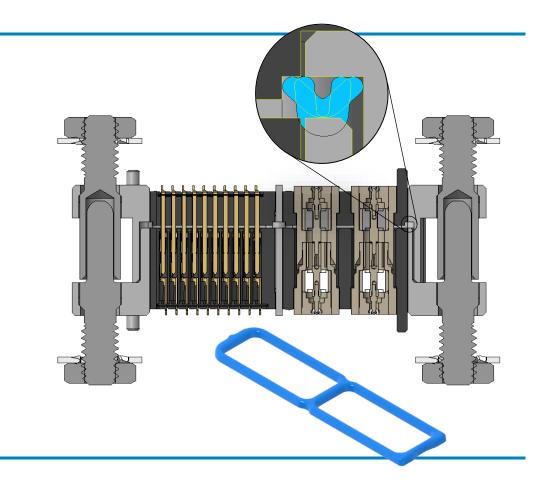
Hardware engages Metal shells engage HD pins engage insulator HD pins engage socket, RF contacts engage insulator HD pins start wipe RF contacts start to engage alignment features RF ground contacts start wipe RF signal contacts start wipe

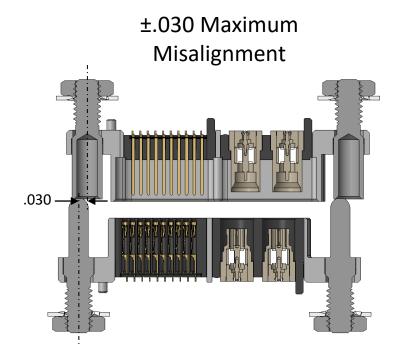


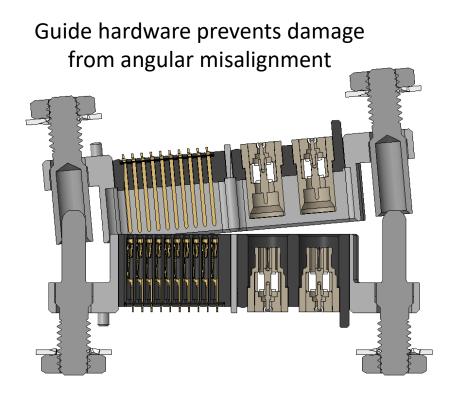
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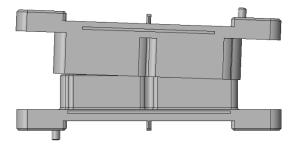




Keyed Interface

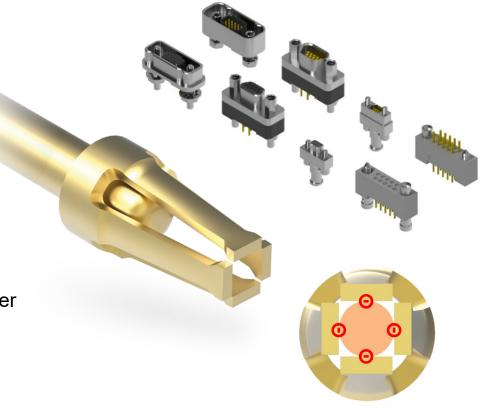


End keys along with the keys between bays prevent Interface from being partially mated at an angle when 180° out



Market Requirements: Voice of the Customer

- Multiple points of contact 50µ Gold
- Availability
- Configurability
- Class 3 SMT
- Mix Signals Power/Signal/RF
- Metal Shells
- Back sealing
- High Density .050 or smaller
- High Shock and Vibration Mil grade or better
- Panel Mountable
- High Speed and LVDS Capable



High-Density (HD) Rugged Contacts



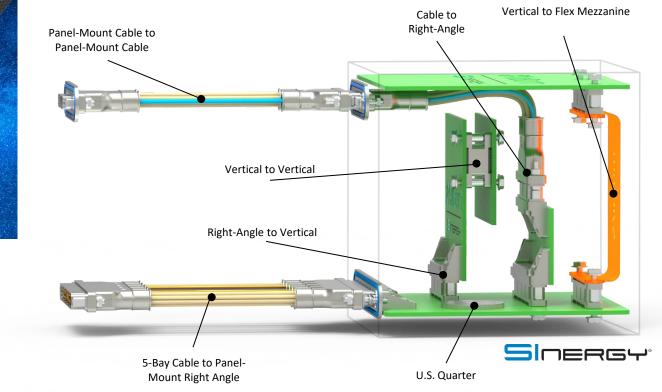
A new contact system designed for reliability, manufacturability, & high-speed capability

- 4 points of contact x and y axis
- One piece design for vertical, right angle and cable
- IPC-610 Class 3 surface mount capable (J-Lead)

- Optimal normal force for low contact resistance
- Stamped and formed to reduce cost
- Optimized impedance

Industry Applications - 1U - 10cm Cube Sat





Conclusion

SINERGY"

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Rugged Interconnects

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- **Contact** Multiple Points/Axis
- Metal Shells Rigidity and Tolerance
- Materials High Strength
- Alignment Features
- SW<u>aP</u>-C

NAIRBORNThank You!